

TE Internal #: 2227303-1 SFP, SFP+ & zSFP+, Cage, Data Rate (Max) 4 Gb/s, Internal /External EMI Springs, zSFP+ Thermally Enhanced, Not Optional, 1 x 1, Through Hole - Solder

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Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+



Pluggable I/O Product Type: Cage

Data Rate (Max): 4 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: **zSFP+ Thermally Enhanced**

Lightpipe Options: Not Optional

Features

Product Type Features



Form Factor	SFP
Cage Туре	Single
Pluggable I/O Product Type	Cage
Lightpipe Options	Not Optional
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 × 1
Number of Ports	1
Electrical Characteristics	
Data Rate (Max)	4 Gb/s
Contact Features	
Tail Plating Material	Tin

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Termination Features

Termination Post & Tail Length	3.56 mm[.14 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Cage Material	Stainless Steel
Dimensions	
PCB Thickness (Recommended)	1.5 mm[.059 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Heat Sink Compatible	No
For Use With Pluggable I/O Products	SFP SMT Connector
Pluggable I/O Applications	zSFP+ Thermally Enhanced
Packaging Features	

Packaging	Method
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Box & Tray, Tray

Other

EMI Containment Feature Type

Internal/External EMI Springs

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 260°C

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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # CAT-SF59-C76264 SFP Connectors



TE Part # 1888901-1 SFP+ EMI Plug



TE Part # 1367147-1 SFP COVER, UNPLATED



TE Part # 1367147-3 SFP COVER, UNPL, NO LOGO





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Customers Also Bought



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Documents

CAD Files

Customer View Model ENG_CVM_CVM_2227303-1_C1.3d_stp.zip

English

Customer View Model ENG_CVM_CVM_2227303-1_C1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2227303-1_C1.3d_igs.zip

English

3D PDF

3D

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Product Specifications

Application Specification

English

Product Environmental Compliance MD_2227303-1_08142017457_dmtec

English

MD_2227303-1_08142017457_dmtec

English